

# XP B5x/msd

N, E, K - Series

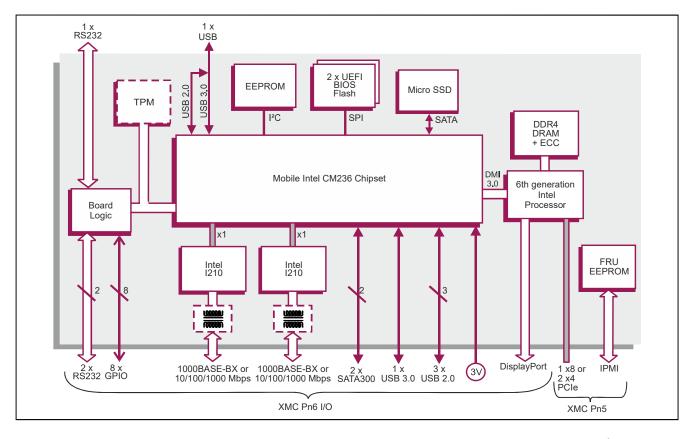
### Processor XMC module based on 6<sup>th</sup> Generation Intel<sup>®</sup> Processor

#### **Key Features**

XP B5x/msd provides high performance control and management capability for any carrier card with an XMC site. Based on a low power 6th Generation Intel® processor, XP B5x/msd is suitable for rugged and extended temperature operating environments.

- 6<sup>th</sup> generation Intel processor suitable for long life cycle deployments
- Built in Solid State Drive for reliable storage
- Wide range of I/O interfaces available on XMC connectors
- Extended temperature and rugged versions available
- Support for Linux<sup>®</sup>, Windows<sup>®</sup> and VxWorks<sup>®</sup>





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#### Processor XMC Module

- utilizes 6<sup>th</sup> generation Intel<sup>®</sup> processor
- XMC Pn6 and Pn5 connectors (build option), select:
  - → VITA 42 XMC (color black)
- → VITA 61 XMC 2.0 (color white)
- configurable PCI Express<sup>®</sup> interface via Pn5
- range of I/O interfaces via Pn6
- front panel I/O interface connectors
- rugged conduction-cooled variants available:
  see separate XP B5x/msd-RC datasheet

#### **Central Processor**

- 4-core Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1505L v5:
- → 8 Mbytes Smart Cache, 2.0 GHz
- → Intel<sup>®</sup> HD Graphics P530
- 2-core Intel<sup>®</sup> Core<sup>™</sup> i3-6102E processor:
- → 3 Mbytes Last Level Cache, 1.9 GHz
  - → Intel<sup>®</sup> HD Graphics 530
- utilizes the Mobile Intel<sup>®</sup> CM236 Chipset

#### DRAM

- up to 16 Gbytes soldered DDR4 DRAM:
  - dual channel architecture
  - → bus speed 2133MHz
- accessible from local processor and base board

#### XMC Interface

- configurable PCI Express (PCIe<sup>®</sup>) interface via XMC Pn5 connector supports:
  - → 1 x8 or 2 x4 PCIe ports
  - → PCle Gen 1, Gen 2 and Gen 3
- XMC Pn5 connector type (build option) determines the maximum PCIe operational speed:
  - → up to Gen 2, VITA 42 connector
  - → up to Gen 3, VITA 61 connector
- supports Root Complex operation
- supports IPMI Interface

#### **Gigabit Ethernet Interfaces**

- 2 x Gigabit Ethernet interfaces via Pn6
- factory build option for 2 x 1000BASE-BX ports
- alternative factory build option for
- 2 x 10/100/1000 Mbps Ethernet ports:
- → 10BASE-T, 100BASE-TX, 1000BASE-T
- → optional on-board magnetics
- support for IEEE I588 precision clock
- implemented by two Intel<sup>®</sup> Ethernet Controller I210 devices via x1 PCIe ports

#### Mass Storage Interfaces

- 2 x SATA300 interfaces via XMC Pn6 connector
- 64 Gbytes soldered Micro SSD

#### Serial Interfaces

- 3 x RS232 serial ports:
  - → port 1 supports Tx, Rx, RTS, CTS, DSR, DCD, DTR, RI via Pn6
  - → port 2 supports Tx, Rx, RTS, CTS, DSR, DCD, DTR, via front panel
  - → port 3 supports Tx, Rx, RTS, CTS via Pn6
- 16550 compatible UARTs

#### **Graphics Interface**

- DisplayPort™ interface:
  → 4096 x 2034 @ 60Hz
- accessible via Pn6
- support for Microsoft<sup>®</sup> DirectX 11.1 on Windows<sup>®</sup>
  support for OpenGL 4.4 on Microsoft<sup>®</sup> Windows<sup>®</sup> and Linux<sup>®</sup>

#### **Other Peripheral Interfaces**

- watchdog timer, 1 x 32-bit Long Duration Timer
- PC Real-Time Clock (no on-board battery):
- → VBAT can be supplied via Pn6
- 4 x USB ports via Pn6:
  - → 1 x USB 3.0 port
  - → 3 x USB 2.0 ports
- 1 x USB 3.0/2.0 port via front panel
  - 8 x GPIO signals via Pn6:
  - processor interrupt capability

#### Flash EPROM

dual 16 Mbytes of BIOS Flash EEPROM

#### **Board Security Features**

- option for Trusted Platform Module (TPM 2.0)
- option for Sanitization Utility Software Package

#### **Firmware Support**

- UEFI 2.4 boot firmware (BIOS) :
  - → UEFI 2.4 support
  - → includes Compatibility Support Module
  - → implements Secure Boot
- LAN boot firmware included

#### Software Support

support for Linux<sup>®</sup>, Windows<sup>®</sup> and VxWorks<sup>®</sup>

#### **Optional Built-In Test (BIT) Support**

 Power-on BIT (PBIT), Initiated BIT (IBIT), Continuous BIT (CBIT)

#### Electrical Specification

- typical current figure (1.9 GHz, 8 Gbytes DRAM):
  +5V @ 4.0A
- +5V VPWR, voltage +5% / -5%
- +12V VPWR is not supported
- supports board power management, under software control

#### Safety

 PCB (PWB) manufactured with flammability rating of UL94V-0

#### **Environmental Specification**

- operating temperatures:
  - → 0°C to +55°C (N–Series)
  - → -25°C to +70°C (E-Series)
  - → -40°C to +75°C (K-Series)
- non-operating temperature: -40°C to +85°C
- 5% to 95% relative humidity, non-condensing:
- K-Series includes humidity sealant

#### Mechanical Specification

- single-width CMC (Common Mezzanine Card) IEEE 1386 form factor: (74mm x 149mm)
- 10mm height stack module

## Specification